

STGP15M65DF2

Trench gate field-stop IGBT M series, 650 V, 15 A low-loss in a TO-220 package

Datasheet - production data

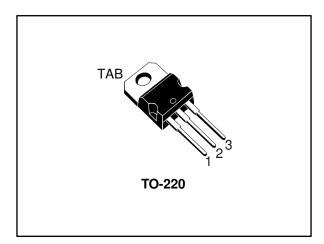
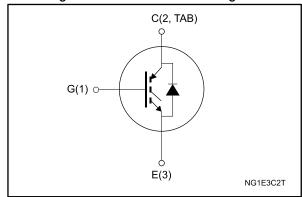


Figure 1: Internal schematic diagram



Features

- 6 µs of short-circuit withstand time
- V_{CE(sat)} = 1.55 V (typ.) @ I_C = 15 A
- Tight parameter distribution
- Safer paralleling
- Positive V_{CE(sat)} temperature coefficient
- Low thermal resistance
- Soft and very fast recovery antiparallel diode
- Maximum junction temperature: T_J = 175 °C

Applications

- Motor control
- UPS
- PFC
- General purpose inverter

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|--------------|-----------|---------|---------|
| STGP15M65DF2 | G15M65DF2 | TO-220 | Tube |

Contents STGP15M65DF2

Contents

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STGP15M65DF2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|--|-------------|------|
| V _{CES} | Collector-emitter voltage (V _{GE} = 0 V) | 650 | V |
| 1- | Continuous collector current at T _C = 25 °C | 30 | Α |
| lc | Continuous collector current at T _C = 100 °C | 15 | Α |
| ICP ⁽¹⁾ | Pulsed collector current | 60 | Α |
| V_{GE} | Gate-emitter voltage | ±20 | V |
| l _F | Continuous forward current at T _C = 25 °C 30 | | Α |
| l _F | Continuous forward current at T _C = 100 °C 15 | | Α |
| I _{FP} ⁽¹⁾ | Pulsed forward current | 60 | Α |
| Ртот | Total dissipation at T _C = 25 °C | 136 | W |
| Tstg | Storage temperature range - 55 to 150 ° | | °C |
| T_J | Operating junction temperature range | - 55 to 175 | °C |

Notes

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|--------|--|-------|------|
| RthJC | Thermal resistance junction-case IGBT | 1.1 | °C/W |
| RthJC | Thermal resistance junction-case diode | 2.08 | °C/W |
| RthJA | Thermal resistance junction-ambient | 62.5 | °C/W |

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by maximum junction temperature.

2 Electrical characteristics

 $T_{\rm J}$ = 25 °C unless otherwise specified.

Table 4: Static characteristics

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|--|---|------|------|------|------|
| V _{(BR)CES} | Collector-emitter breakdown voltage | $V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$ | 650 | | | ٧ |
| | | $V_{GE} = 15 \text{ V}, I_{C} = 15 \text{ A}$ | | 1.55 | 2.0 | |
| V _{CE(sat)} Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 15 A T _J = 125 °C | | 1.9 | | V | |
| | V _{GE} = 15 V, I _C = 15 A T _J = 175 °C | | 2.1 | | | |
| | | I _F = 15 A | | 1.7 | 2.6 | V |
| V_{F} | Forward on-voltage | I _F = 15 A T _J = 125 °C | | 1.5 | | V |
| | | I _F = 15 A T _J = 175 °C | | 1.4 | | V |
| $V_{\text{GE(th)}}$ | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_C = 500 \mu A$ | 5 | 6 | 7 | V |
| Ices | Collector cut-off current | V _{GE} = 0 V, V _{CE} = 650 V | | | 25 | μΑ |
| Iges | Gate-emitter leakage current | $V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$ | | | ±250 | μΑ |

Table 5: Dynamic characteristics

| Table of Bynamic onaracteristics | | | | | | |
|----------------------------------|------------------------------|--|------|------|------|------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| Cies | Input capacitance | | - | 1250 | 1 | pF |
| Coes | Output capacitance | V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0 V | - | 80 | 1 | pF |
| Cres | Reverse transfer capacitance | VGE = 0 V | - | 25 | 1 | pF |
| Qg | Total gate charge | $V_{CC} = 520 \text{ V}, I_{C} = 15 \text{ A},$ | - | 45 | 1 | nC |
| Qge | Gate-emitter charge | V _{GE} = 0 to 15 V (see <i>Figure 30: " Gate</i> | - | 11 | 1 | nC |
| Qgc | Gate-collector charge | charge test circuit" | - | 15 | - | nC |

STGP15M65DF2 Electrical characteristics

Table 6: IGBT switching characteristics (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|------------------------------|--|------|------|------|------|
| t _{d(on)} | Turn-on delay time | | | 24 | - | ns |
| tr | Current rise time | | | 7.8 | - | ns |
| (di/dt) _{on} | Turn-on current slope | V _{CE} = 400 V, I _C = 15 A, | | 1570 | - | A/μs |
| t _{d(off)} | Turn-off delay time | $V_{GE} = 15 \text{ V}, R_{G} = 12 \Omega$ | | 93 | - | ns |
| t _f | Current fall time | (see Figure 29: " Test circuit | | 106 | - | ns |
| E _{on} (1) | Turn-on switching energy | for inductive load switching") | | 0.09 | - | μJ |
| E _{off} (2) | Turn-off switching energy | | | 0.45 | - | μJ |
| Ets | Total switching energy | | | 0.54 | - | μJ |
| t _{d(on)} | Turn-on delay time | | | 24.8 | - | ns |
| tr | Current rise time | | | 9.2 | - | ns |
| (di/dt) _{on} | Turn-on current slope | V _{CE} = 400 V, I _C = 15 A, | | 1300 | - | A/μs |
| t _{d(off)} | Turn-off delay time | R _G = 15 Ω, V _{GE} = 15 V, T _J = 175 °C | | 96 | - | ns |
| t _f | Current fall time | (see Figure 29: " Test circuit | | 169 | - | ns |
| E _{on} ⁽¹⁾ | Turn-on switching energy | for inductive load switching") | | 0.22 | - | μJ |
| E _{off} ⁽²⁾ | Turn-off switching energy | | | 0.61 | - | μJ |
| E _{ts} | Total switching energy | | | 0.83 | - | μJ |
| | Chart aircuit withstand time | V _{CC} ≤ 400 V, V _{GE} = 15 V, T _{Jstart} = 150 °C | 6 | | - | |
| t _{sc} | Short-circuit withstand time | V _{CC} ≤ 400 V, V _{GE} = 13 V, T _{Jstart} = 150 °C | 10 | | - | μs |

Notes:

Table 7: Diode switching characteristics (inductive load)

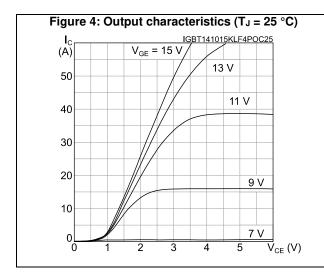
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-----------------------|---|---|------|------|------|------|
| trr | Reverse recovery time | | - | 142 | 1 | ns |
| Qrr | Reverse recovery charge | $I_F = 15 \text{ A}, V_R = 400 \text{ V},$ | - | 525 | - | nC |
| Irrm | Reverse recovery current | V _{GE} = 15 V, di/dt = 1000 A/μs | - | 13.4 | 1 | Α |
| dl _{rr/} /dt | Peak rate of fall of reverse recovery current during t_{b} | (see Figure 29: " Test circuit for inductive load switching") | - | 790 | ı | A/µs |
| Err | Reverse recovery energy | | - | 64 | 1 | μJ |
| t _{rr} | Reverse recovery time | | - | 241 | ı | ns |
| Qrr | Reverse recovery charge | I _F = 15 A, V _R = 400 V, V _{GE} = 15 V. | - | 1690 | 1 | nC |
| I _{rrm} | Reverse recovery current | di/dt = 1000 A/µs, | - | 20 | - | Α |
| dl _{rr/} /dt | Peak rate of fall of reverse recovery current during t _b | T _J = 175 °C (see Figure 29: " Test circuit for inductive load switching") | - | 420 | 1 | A/µs |
| Err | Reverse recovery energy | , | - | 176 | 1 | μJ |

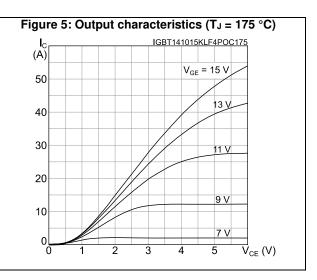
⁽¹⁾Including the reverse recovery of the diode.

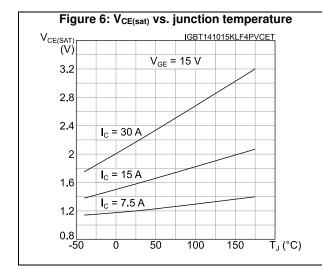
 $[\]ensuremath{^{(2)}}\mbox{Including}$ the tail of the collector current.

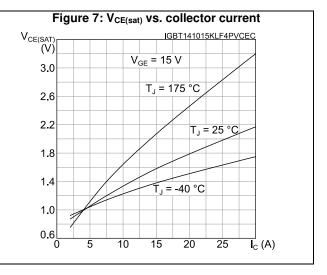
2.1 Electrical characteristics (curves)

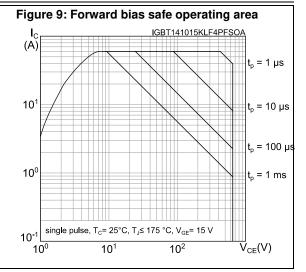
Figure 3: Collector current vs. case temperature I_{C} (A) $V_{GE} \ge 15 \text{ V}, T_{J} \le 175 ^{\circ}\text{C}$ $V_{GE} \ge 15 \text{ V}, T_{J} \le 175 ^{\circ}\text{C}$

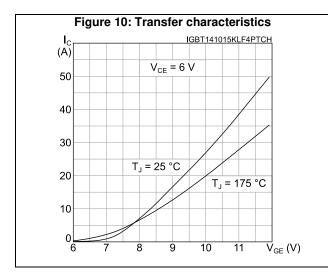


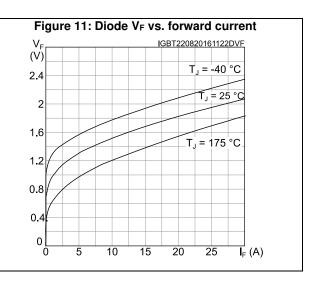


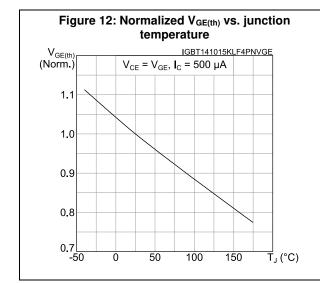












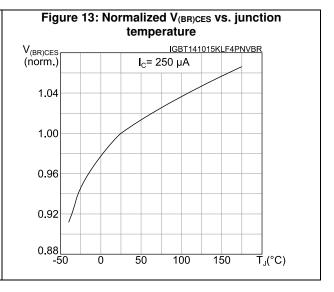


Figure 14: Capacitance variations

C
(pF)

10³

10²

C_{RES}

10¹

10¹

10⁰

10⁻¹

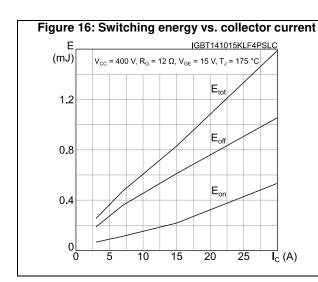
10⁰

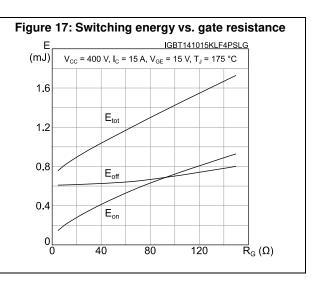
10¹

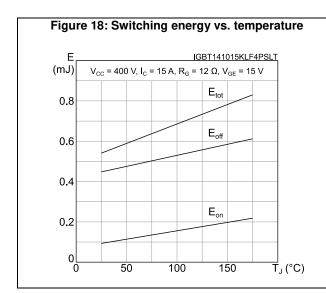
10¹

10²

V_{CE}(V)







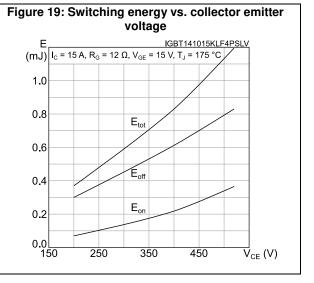
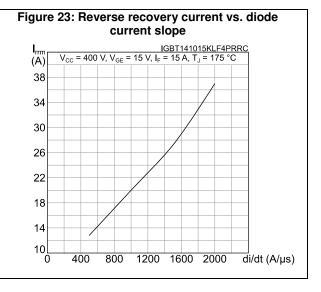
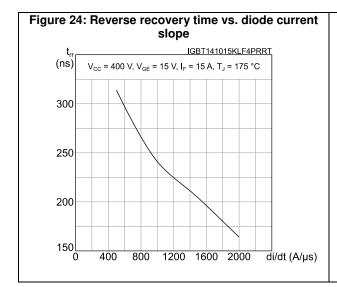
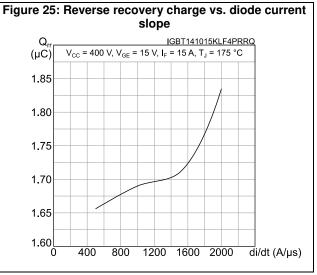
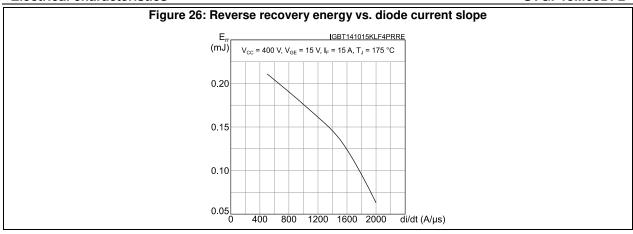


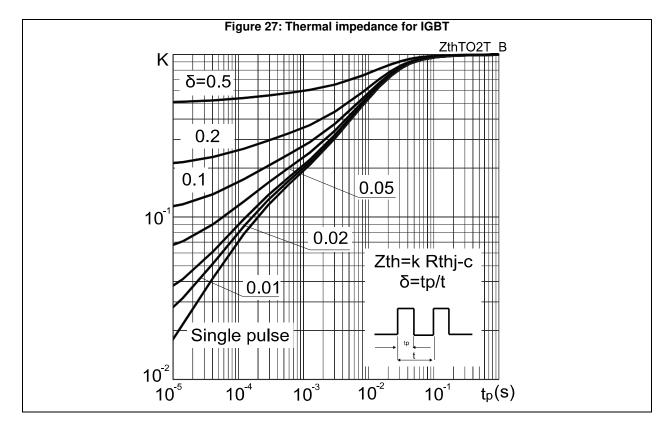
Figure 20: Short-circuit time and current vs. V_{GE} $\frac{\text{IGBT141015KLF4PSCV}}{\text{V}_{\text{CC}} \leq 400 \text{ V, T}_{\text{J}} \leq 150 \text{ °C}} \text{(A)}$ ol $\overline{V}_{GE}(V)$

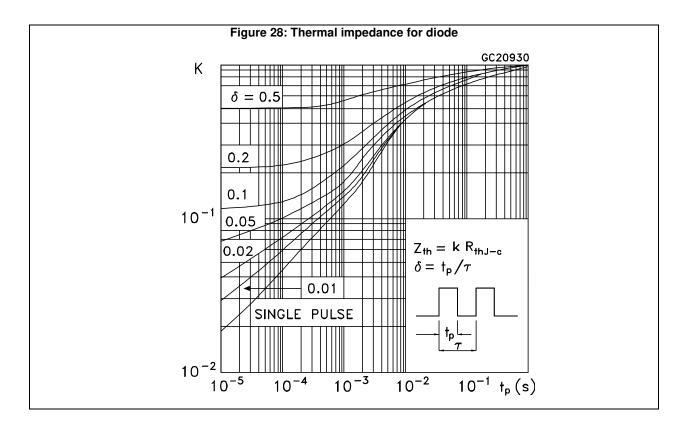






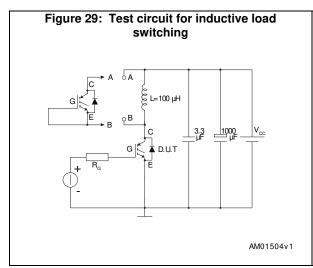


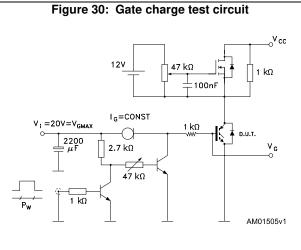


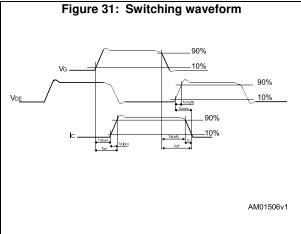


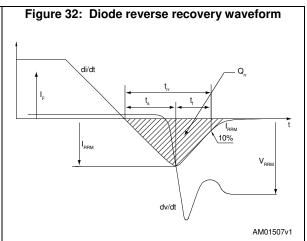
Test circuits STGP15M65DF2

3 Test circuits









STGP15M65DF2 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220 type A package information

Figure 33: TO-220 type A package outline

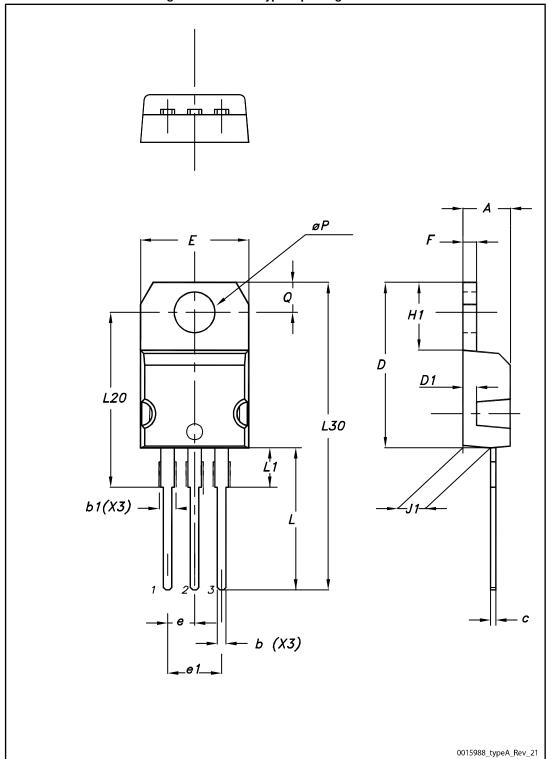


Table 8: TO-220 type A package mechanical data

| Dim. | 7,7 | mm | |
|--------|-------|-------|-------|
| Diiii. | Min. | Тур. | Max. |
| А | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.55 |
| С | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10.00 | | 10.40 |
| е | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13.00 | | 14.00 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| øΡ | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Revision history STGP15M65DF2

5 Revision history

Table 9: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 14-Oct-2015 | 1 | First release. |
| 13-Nov-2015 | 2 | Document status promoted from preliminary to production data. |
| 22-Aug-2016 | 3 | Updated Table 2: "Absolute maximum ratings" and Table 6: "IGBT switching characteristics (inductive load)". Updated Figure 16: "Switching energy vs. collector current", Figure 17: "Switching energy vs. gate resistance", Figure 18: "Switching energy vs. temperature" and Figure 19: "Switching energy vs. collector emitter voltage". Changed Figure 11: "Diode VF vs. forward current". |
| 28-Apr-2017 | 4 | Modified: title, features and applications on cover page. Modified Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 7: "Diode switching characteristics (inductive load)". Minor text changes. |

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